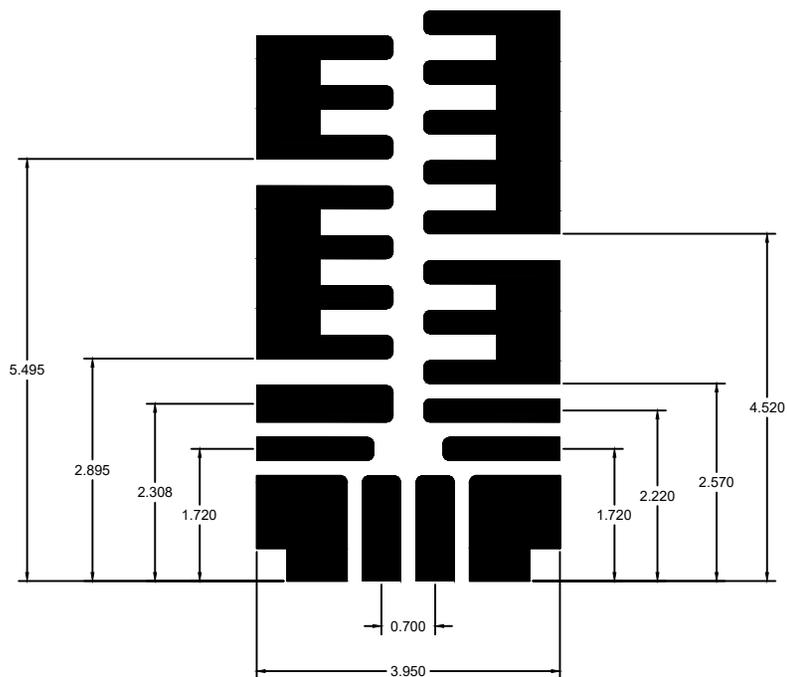
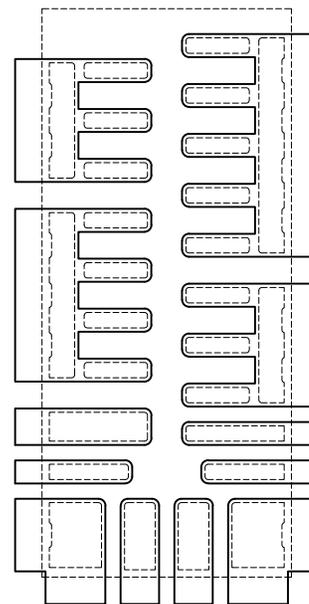


## RECOMMENDED LAND PATTERN



## PACKAGE OVERLAY



### NOTES:

1. REFERENCE PKG. OUTLINE: 21-100409
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO LEADED, PbFREE PACKAGES.
5. ALL DIMENSIONS IN MM.

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TITLE:  
PACKAGE LAND PATTERN,  
[F123A7F-3] FC2QFN

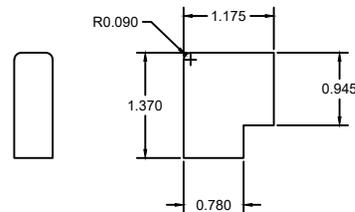
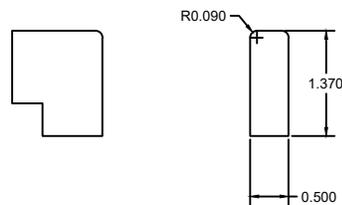
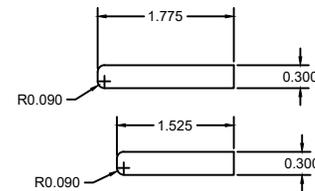
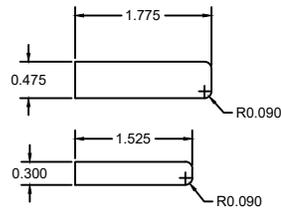
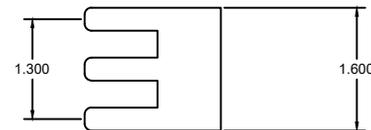
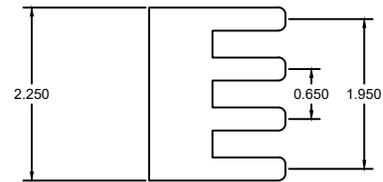
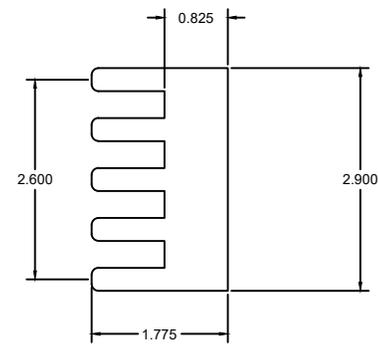
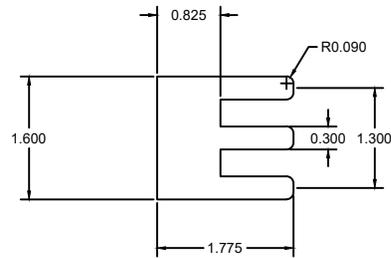
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# PAD DETAILS



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